



Product Change Notification

111766 - 01

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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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Product Change Notification

Change Notification #: 111766 - 01
Change Title: Intel® Desktop Board DB75EN, Boxed & Bulk
PCN 111766-01, Product Design
PCB Change
Reason for Revision: Implementation Date Change
Date of Publication: December 05, 2012

Key Characteristics of the Change:
Product Design

Forecasted Key Milestones:

| | |
|---|---------------------|
| Date Customer Must be Ready to Receive Post-Conversion Material: | Jan 14, 2013 |
|---|---------------------|

Description of Change to the Customer:

Reason for Revision: Implementation Date Change

The PCB is being changed to provide additional margin for the VR (voltage regulator) when exceeding the VR temperatures under stress conditions.

Customer Impact of Change and Recommended Action:

This change has been thoroughly evaluated to ensure there is no quality, reliability, or functional implication to our customers. Intel is not recommending additional qualification of these changes on platforms received from Intel.

Intel will attempt to deplete pre-conversion material before shipping post-conversion material but there is a possibility of Intel shipping mixed inventory. Therefore, customers will need to manage and migrate to the post-conversion material as soon as possible.

Milestone dates are estimates and subject to change based on business and operational conditions.

Products Affected / Intel Ordering Codes:

| Product Code | MM# | Pre Change AA | Post Change AA |
|--------------|--------|---------------|----------------|
| BOXDB75EN | 918236 | G39650-302 | G39650-400 |
| BLKDB75EN | 918237 | G39650-302 | G39650-400 |

PCN Revision History:

| Date of Revision: | Revision Number: | Reason: |
|--------------------------|-------------------------|----------------------------|
| September 18, 2012 | 00 | Originally Published PCN |
| December 5, 2012 | 01 | Implementation Date Change |